

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Jens Heinrich	04/05/2011
Torsten Huisinga	04/05/2011
Ralf Richter	04/05/2011
Ronny Pfuetzner	04/06/2011
RECEIVING PARTY DATA	
Name:	GLOBALFOUNDRIES Inc.
Street Address:	Maples Corporate Services Limited
Internal Address:	PO Box 309, Ugland House
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
Postal Code:	KY1-1104
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12040399
CORRESPONDENCE DATA	
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	7139344055
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Address Line 4:	Houston, TEXAS 77042
ATTORNEY DOCKET NUMBER:	2162.195500
NAME OF SUBMITTER:	J. Mike Amerson

Assignment

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Signature:	/J. Mike Amerson/
Date:	05/20/2011
Total Attachments: 1 source=Assignment#page1.tif	
RECEIPT INFORMATION	
EPAS ID:	PAT1567049
Receipt Date:	05/20/2011
Fee Amount:	\$40

3. Nature of Conveyance – Corrected Assignment to remove incorrect serial number from Reel/Frame 026316/0132

Form PTO-1595 (Rev. 03-11)
OMB No. 0651-0027 (exp. 03/31/2012)U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Same

Additional name(s) of conveying party(ies) attached? Yes No**2. Name and address of receiving party(ies)**Name: Same

Internal Address: _____

Street Address: _____

City: _____

State: _____

Country: _____

Zip: _____

Additional name(s) & address(es) attached? Yes No**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) _____

 Assignment Merger Security Agreement Change of Name Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Other See attached**4. Application or patent number(s):** This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

13040399

Additional numbers attached? Yes No**5. Name and address to whom correspondence concerning document should be mailed:**Name: Same

Internal Address: _____

Street Address: _____

City: _____

State: _____

Zip: _____

Phone Number: _____

Fax Number: _____

Email Address: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ _____

 Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)**8. Payment Information**Deposit Account Number 50-0786Authorized User Name J. Mike Amerson**9. Signature:**/J. Mike Amerson/
Signature2011-05-26
Date

J. Mike Amerson

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

4

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

PATENT
REEL: 026399 FRAME: 0344

PATENT
FILE NO. BD146

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, do hereby:

SELL, ASSIGN AND TRANSFER to GLOBALFOUNDRIES Inc., having a business address of Maples Corporate Services Limited, PO Box 309, Uglund House, Grand Cayman KY1-1194, Cayman Islands, and GLOBALFOUNDRIES Dresden Module One Limited Liability Company & Co. KG, having a business address of Wilschdorfer, Landstraße 101, 01109 Dresden, Germany (the "Assignees"), the entire right, title and interest for the United States and all foreign countries in and to any and all improvements which are disclosed in the application for United States Letters Patent, Serial No. 13/040,399, filed March 3, 2011 entitled **A SEMICONDUCTOR DEVICE COMPRISING METALLIZATION LAYERS OF REDUCED INTERLAYER CAPACITANCE BY REDUCING THE AMOUNT OF ETCH STOP MATERIALS**, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignees;

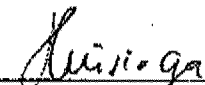
WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the Assignees, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignees all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignees shall consider desirable for vesting title to such improvements in the Assignees, and for securing, maintaining and enforcing proper patent protection for such improvements;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignees.

Signature: 
JENS HEINRICH

Date: 04/05/11

Signature: 
TORSTEN HUISINGA

Date: 04/05/11

Signature: 
RALF RICHTER

Date: 04/05/11

Signature: 
RONNY PFUETZNER

Date: 04/06/11